RoHS

COMPLIANT

FREE





Bi-Directional P-Channel MOSFET/Power Switch

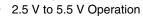
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
± 7	0.170 at V _{GS} = - 4.5 V	± 2.4		
	0.240 at V _{GS} = - 2.5 V	± 2.0		

DESCRIPTION

The Si3831DV is a low on-resistance p-channel power MOSFET providing bi-directional blocking and conduction. Bi-directional blocking is facilitated by combining a 4-terminal symmetric p-channel MOSFET with a body bias selector circuit^a. Circuit operation automatically biases the p-channel body to the most positive source/drain potential thereby maintaining a reverse bias across the diode present between the source/drain terminals. Off-state device blocking characteristics are symmetric, facilitating bi-directional blocking for high-side battery switching in portable products. Gate drive is facilitated by negatively biasing the gate relative to the body potential. The off-state is achieved by biasing the gate to the most positive supply voltage or to the body potential. The Si3831DV is available in a 6-pin TSOP-6 package rated for the - 25 °C to 85 °C commercial temperature range.

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Low R_{DS(on)} Symmetrical P-Channel MOSFET
- Integrated Body Bias For Bi-Directional Blocking



- Exceeds ± 2 kV ESD Protected
- Solution for High-Side Battery Disconnect Switching (BDS)
- Supports Battery Switching in Multiple Battery Cell Phones, PDAs and PCS Products
- Low Profile, Small Footprint TSOP-6 Package
- Compliant to RoHS Directive 2002/95/EC

APPLICATION CIRCUITS

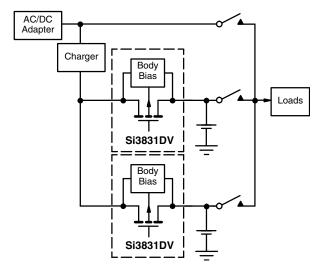


Figure 1. Charger Demultiplexing

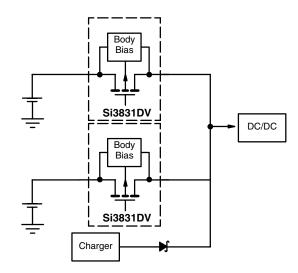


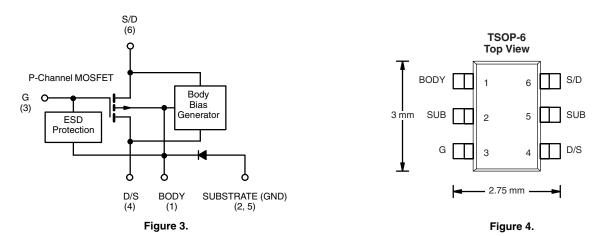
Figure 2. Battery Multiplexing (High-Side Switch)

Note:

a. Patents pending.



FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



Ordering Information: Si3831DV-T1-E3 (Lead (Pb)-free) Si3831DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted				
Parameter		Symbol	Limit	Unit
Drain-Source Voltage, Source-Drain Voltage ^a		V _{DS}	- 7.0 to + 7.0	
Source-Body, Drain-Body, Gate-Body Voltage		V_{SB}, V_{DB}, V_{GB}	0.3 to - 7.0	V
ody-Substrate Voltage		V _{BSUB}	+ 7.0 to - 0.3	
Continuous Dunin to Course Courset /T 150 °C\a,	T _A = 25 °C	- I _D	± 2.4	А
Continuous Drain-to-Source Current (T _J = 150 °C) ^{a, b}	T _A = 70 °C		± 2.0	
Pulsed Drain-to-Source Current ^a		I _{DM}	± 8	
M	T _A = 25 °C	- P _D	1.5	w
Maximum Power Dissipation ^b	T _A = 70 °C		1.0	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

RECOMMENDED OPERATING RANGE				
Parameter	Symbol	Range	Unit	
Drain-Source Voltage ^a	V_{DS}	- 5.5 to 5.5		
Gate-Drain, Gate-Source Voltage	V_{GD} , V_{GS}	0 to - 5.5	V	
Source-Body, Drain-Body, Gate-Body Voltage	V_{SB}, V_{DB}, V_{GB}	0 to - 5.5]	
Drain-to-Source Current ^{a, b}	I _{DS}	± 2.4	Α	
Body-Source Current	I _{BS}	0 to 10	μΑ	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Marrian II matica to Ambicath	R _{thJA}	80	°C/W	
Maximum Junction-to-Ambient ^b		125	- C/VV	

Notes:

- a. Bi-directional.
- b. Surface Mounted on FR4 board, $t \le 5 \ s.$
- c. Surface Mounted on FR4 board, Steady-State.



SPECIFICATIONS $V_{BS} = 0 \text{ V}$, $T_J = 25 ^{\circ}\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4			٧
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = -5.5 \text{ V to} + 0.3 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = -5.5 \text{ V}, V_{GS} = 0 \text{ V}, V_{SB} = 0 \text{ V}$			- 1	μΑ
	IDSS	$V_{DS} = -5.5 \text{ V}, V_{GS} = 0 \text{ V}, V_{SB} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			- 5	
	I _{D(on)}	V _{DS} = - 3 V, V _{GS} = - 4.5 V	- 8			^
On-State Drain Current ^a		V _{DS} = - 3 V, V _{GS} = - 2.5 V	- 3			Α
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 2.4 A		0.130	0.170	Ω
		V _{GS} = - 2.5 V, I _D = - 2.0 A		0.180	0.240	
Dynamic ^b	<u>'</u>			1	•	
Total Gate Charge	Q_g	V _{DS} = - 5 V, V _{GS} = - 4.5 V, I _D = - 2.4 A		2.0	4.0	nC
Gate-Source Charge	Q_{gs}			0.23		
Gate-Drain Charge	Q _{gd}			0.14		
Turn-On Delay Time	t _{d(on)}	$V_{DD} = -3 \text{ V, } R_L = 3 \Omega$ $I_D \cong -1.0 \text{ A, } V_{GEN} = -4.5 \text{ V, } R_g = 6 \Omega$		12	25	
Rise Time	t _r			55	110	ns
Turn-Off Delay Time	t _{d(off)}			90	180	
Fall Time	t _f			85	170	

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

GATE BUFFER REFERENCE

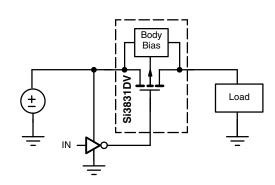


Figure 5. Gate Buffer Referenced to Most Positive Supply

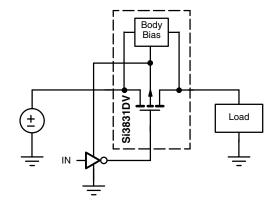
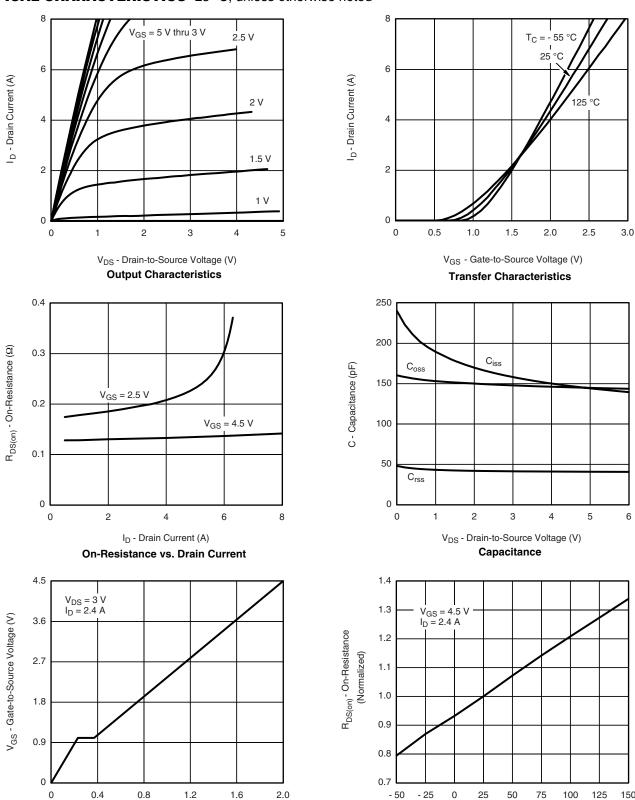


Figure 6. Gate Buffer Referenced to Body Bias Pin

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Q_g - Total Gate Charge (nC)

Gate Charge

T_J - Junction Temperature (°C)

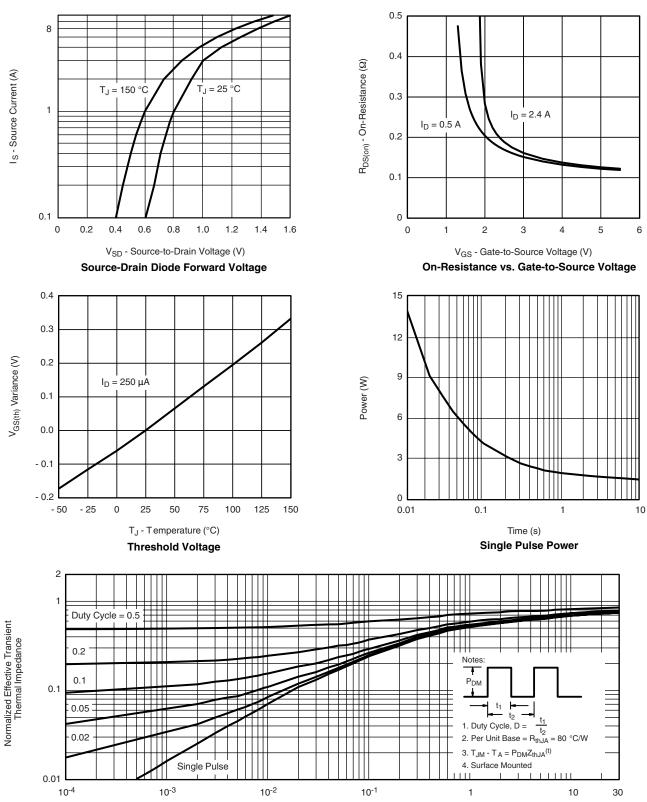
On-Resistance vs. Junction Temperature







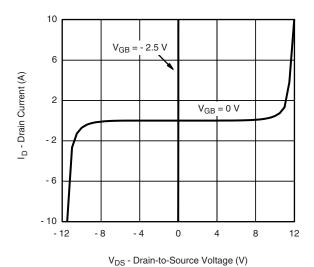
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Square Wave Pulse Duration (s)

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Bi-Directional Blocking Drain-Source Voltage

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